

# **Connector Datasheet**

## PT061101XXB1

Pitch 1.27 pin header Single row DIP SH

| Prepared: Hyde |                  | Approved: ADAM |            |          |
|----------------|------------------|----------------|------------|----------|
| Checked: FEIDI |                  | Customer:      |            |          |
| Version        | Changed Reason   |                | Changed by | Date     |
| 01             | Original version |                | Hyde       | 20191014 |
|                | XXY              |                |            |          |
|                |                  |                |            |          |

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## TECHNICAL INFORMATION

#### MATERIALS

- Housing: Thermoplastic High Temperature, UL 94V-0.
- Contact: Copper Alloy, Reference Drawing Description.
- Gold flash plated overall

#### ELECTRICAL PERFORMANCE

- Current Rating: 1A Max. / Pin
- Voltage Rating: 30V DC Max.

#### MECHANICAL PERFORMANCE

- Mating force : 220g Max. / Pin
- Unmating force: 20g Min. / Pin
- Contact Retention Force : Male: 300gf / pin Min.
- Durability : 100 cycles

### PACKING

• Box

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#### TEST REQUIREMENTS AND PROCEDURES SUMMARY

| Test Description                   | Requirement   | PROCEDURED   |
|------------------------------------|---|--|
| Examination of product             | Meets requirements of product drawing and Specification.  | Visual inspection<br>No physical damage  |
| Electrical                         |   |  |
| Contact Resistance                 | 40mΩ Max.<br>After Test 60mΩ Max.   | EIA-364-23C  |
| Insulation Resistance              | 1000MΩ Min. at 500V DC /<br>2min.   | EIA-364-21-E   |
| Dielectric Withstanding<br>Voltage | No breakdown at 500V RMS  | ЕІА-364-20-Е   |
| MECHANICAL                         |   |  |
| Durability                         | 100 Cycles  | EIA-364-09C  |
| Mating Force                       | 220gf Max. /Pin   | Speed 25±3mm/minute  |
| Un-Mating Force                    | 20gf Max. /Pin  | Speed 25±3mm/minute  |
| Contact Retention Force            | 300gf Min./Pin  | EIA-364-29C  |
| ENVIRONMENTAL                      |   |  |
| Humidity                           | Meets requirements of product<br>drawing and electrical<br>specification.   | EIA-364-31C method II Condition A  |
| Salt spray                         | Meets requirements of product drawing and electrical specification.   | Temperature: 35℃ ± 2℃<br>Density of salt water: 5 ± 1%<br>Period: 4hours   |
| Low Temperature                    | Meets requirements of product<br>drawing and electrical<br>specification  | The connector housing shall be<br>store at temperature of -25 ± 3°C<br>for 48hours   |
| Dry heat                           | Meets requirements of product<br>drawing and electrical<br>specification  | The connector housing shall be<br>store at temperature of 85 ± 2°C for<br>96hours<br>EIA-364-17C   |
| PHYSICAL                           | <i>j</i>  | ·  |
| Solderability                      | The test area shall be covered<br>more than 95% of immersed<br>area with flash solder   | Solder Temperature: $245^{\circ}$ C ± 5 °C Immersion Period: $3 \pm 0.5$ sec.  |
| Resistance to Soldering<br>Heat    | <ol> <li>Without deformation of case<br/>or excessive loosen.</li> <li>Electrical characteristics shall<br/>be satisfied</li> </ol> | Place the connector on the P.C.<br>Board, then<br>immerse the solder pin up to the<br>surface of the<br>board in the solder bath at $260^{\circ}C \pm 5^{\circ}C$<br>for 5 sec.(Included $245^{\circ}C \pm 5^{\circ}C$ for |
|                                    |   | 10 sec.)   |

Figure 1

NOTE: Shall meet visual requirements, show no physical damages.

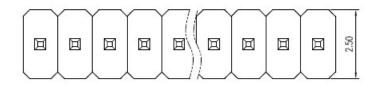
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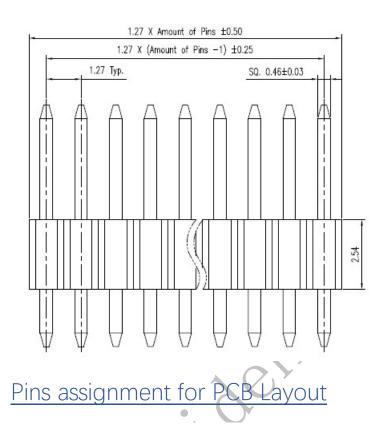


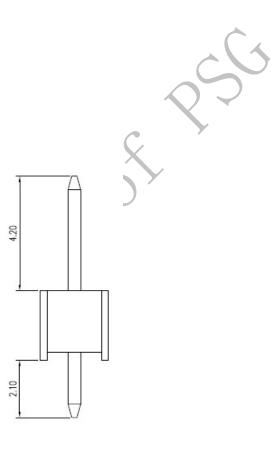
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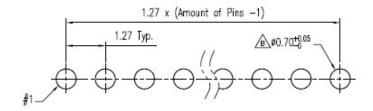
## **Component Configuration and Dimensions**

#### PT061101XXB1=> XX: Amount of Pins









Recommended P.C.B. Layout Layout Tolerance = ± 0.05 mm

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**Others** 

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Note: The product specification only for standard product

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